



III-Nitride Based VCSEL with Curved Mirror on P-Side of the Aperture

Tech ID: 31857 / UC Case 2019-934-0

BACKGROUND

Conventional planar mirrors used in vertical-cavity surface-emitting lasers (VCSELs) suffer from more diffraction loss the longer they become. However, the length of the cavity that is formed by these mirrors can also provide advantages such as tighter mode spacing and better thermal management. There is a need for devices that can realize the advantages of longer cavities while avoiding the diffraction loss that typically accompanies them.

DESCRIPTION

Researchers at the University of California, Santa Barbara have incorporated a curved mirror formed above the p-side of a III-nitride VCSEL to minimize diffraction loss and extend the lifetime and reliability of the device. When using a curved mirror, the reflected light can be focused back into the center of the aperture, thus minimizing diffraction loss. The curved mirror also affords the use of a long cavity, allowing for better thermal management and significant reduction of thermal rollover, thus increasing lifetime and reliability of the VCSEL. Additionally, the tight mode spacing of this technology allows for a greater tolerance of the cavity length, which increases the yield during device growth and fabrication.

ADVANTAGES

- ▶ Minimized diffraction loss
- ▶ Longer device lifetime
- ▶ Improved device reliability

APPLICATIONS

- ▶ VCSELs

PATENT STATUS

Country	Type	Number	Dated	Case
United States Of America	Published Application	20220239068	07/28/2022	2019-934

ADDITIONAL TECHNOLOGIES BY THESE INVENTORS

- ▶ [Lateral Growth Method for Defect Reduction of Semipolar Nitride Films](#)

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OTHER INFORMATION

KEYWORDS

mirror, VCSEL, curved

CATEGORIZED AS

- ▶ [Optics and Photonics](#)
- ▶ [All Optics and Photonics](#)

RELATED CASES

2019-934-0

- ▶ Vertical Cavity Surface-Emitting Lasers with Continuous Wave Operation
- ▶ Eliminating Misfit Dislocations with In-Situ Compliant Substrate Formation
- ▶ III-Nitride-Based Vertical Cavity Surface Emitting Laser (VCSEL) with a Dielectric P-Side Lens
- ▶ Aluminum-cladding-free Nonpolar III-Nitride LEDs and LDs
- ▶ Low-Cost Zinc Oxide for High-Power-Output, GaN-Based LEDs (UC Case 2010-183)
- ▶ Implantable Light Irradiation Device For Photodynamic Therapy
- ▶ Low Temperature Deposition of Magnesium Doped Nitride Films
- ▶ Transparent Mirrorless (TML) LEDs
- ▶ Improved GaN Substrates Prepared with Ammonothermal Growth
- ▶ Optimization of Laser Bar Orientation for Nonpolar Laser Diodes
- ▶ Method for Enhancing Growth of Semipolar Nitride Devices
- ▶ Ultraviolet Laser Diode on Nano-Porous AlGaN template
- ▶ Growth of Polyhedron-Shaped Gallium Nitride Bulk Crystals
- ▶ Nonpolar III-Nitride LEDs With Long Wavelength Emission
- ▶ Improved Fabrication of Nonpolar InGaN Thin Films, Heterostructures, and Devices
- ▶ Growth of High-Quality, Thick, Non-Polar M-Plane GaN Films
- ▶ High-Efficiency, Mirrorless Non-Polar and Semi-Polar Light Emitting Devices
- ▶ Method for Growing High-Quality Group III-Nitride Crystals
- ▶ Controlled Photoelectrochemical (PEC) Etching by Modification of Local Electrochemical Potential of Semiconductor Structure
- ▶ Technique for the Nitride Growth of Semipolar Thin Films, Heterostructures, and Semiconductor Devices
- ▶ MOCVD Growth of Planar Non-Polar M-Plane Gallium Nitride
- ▶ Methods for Fabricating III-Nitride Tunnel Junction Devices
- ▶ Low-Droop LED Structure on GaN Semi-polar Substrates
- ▶ Contact Architectures for Tunnel Junction Devices
- ▶ Semi-polar LED/LD Devices on Relaxed Template with Misfit Dislocation at Hetero-interface
- ▶ Semipolar-Based Yellow, Green, Blue LEDs with Improved Performance
- ▶ III-Nitride-Based Devices Grown On Thin Template On Thermally Decomposed Material
- ▶ Growth of Semipolar III-V Nitride Films with Lower Defect Density
- ▶ III-Nitride Tunnel Junction LED with High Wall Plug Efficiency
- ▶ Tunable White Light Based on Polarization-Sensitive LEDs
- ▶ Cleaved Facet Edge-Emitting Laser Diodes Grown on Semipolar GaN
- ▶ Growth of High-Performance M-plane GaN Optical Devices
- ▶ Packaging Technique for the Fabrication of Polarized Light Emitting Diodes
- ▶ Improved Anisotropic Strain Control in Semipolar Nitride Devices
- ▶ Novel Multilayer Structure for High-Efficiency UV and Far-UV Light-Emitting Devices
- ▶ III-V Nitride Device Structures on Patterned Substrates
- ▶ Method for Increasing GaN Substrate Area in Nitride Devices
- ▶ High-Intensity Solid State White Laser Diode
- ▶ Nitride Based Ultraviolet LED with an Ultraviolet Transparent Contact
- ▶ GaN-Based Thermoelectric Device for Micro-Power Generation
- ▶ Limiting Strain-Relaxation in III-Nitride Heterostructures by Substrate Patterning
- ▶ LED Device Structures with Minimized Light Re-Absorption
- ▶ Growth of Planar Semi-Polar Gallium Nitride
- ▶ High-Efficiency and High-Power III-Nitride Devices Grown on or Above a Strain Relaxed Template
- ▶ UV Optoelectronic Devices Based on Nonpolar and Semi-polar AlInN and AlInGaN Alloys
- ▶ Enhancing Growth of Semipolar (Al,In,Ga,B)N Films via MOCVD

